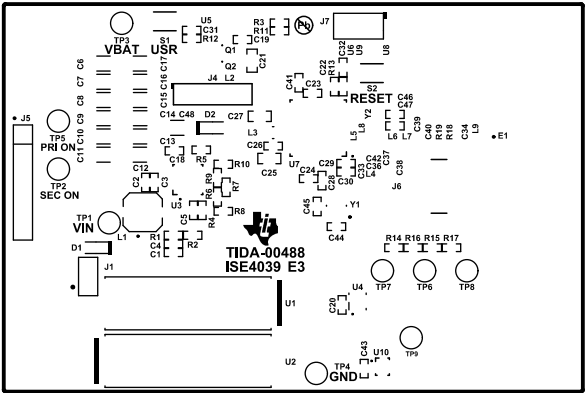
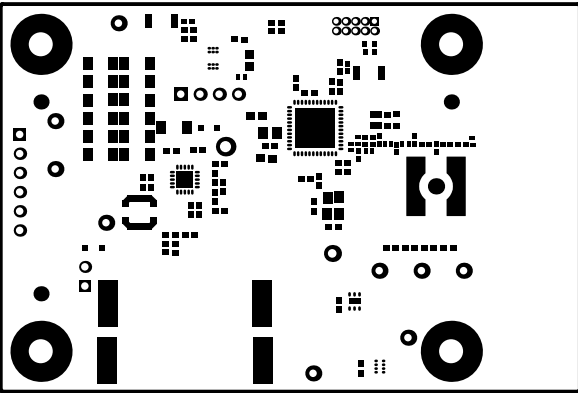
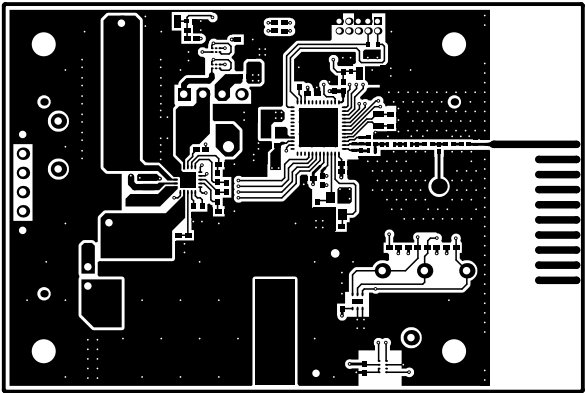




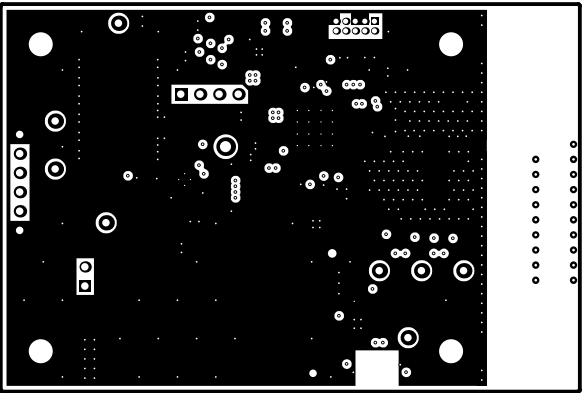
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4039	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00488		
PLOT NAME = Top Overlay	GENERATED : 10/14/2015 10:59:08 AM	TEXAS INSTRUMENTS	



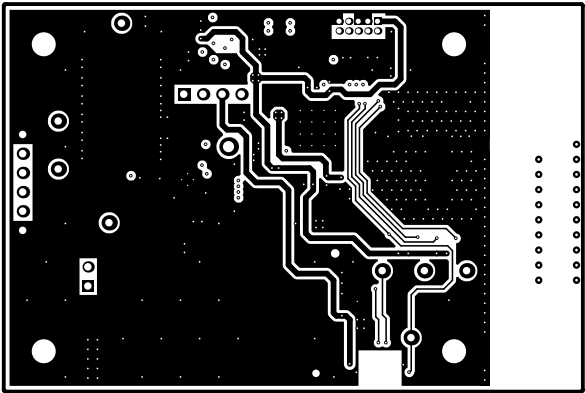
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4039	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00488		
PLOT NAME = Top Solder Mask	GENERATED : 10/14/2015 10:59:10 AM	TEXAS INSTRUMENTS	



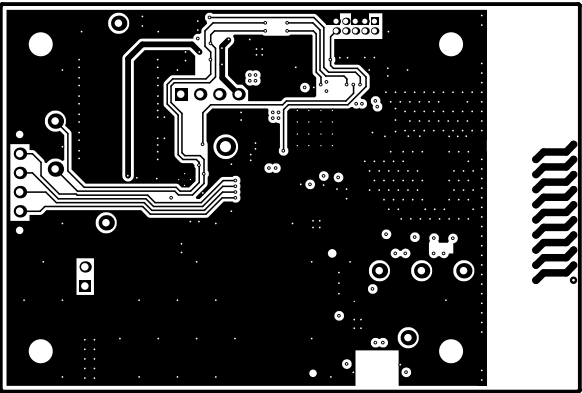
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4039	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Layer 1 - Top Layer	TID #: TIDA-00488		
PLOT NAME = Top Layer	GENERATED : 10/14/2015 10:59:11 AM	TEXAS INSTRUMENTS	



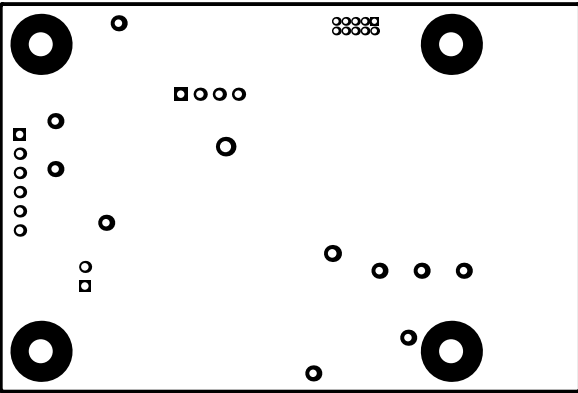
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #:	ISE4039	REV:	E3	SUN REV:	Not In VersionControl
LAYER NAME = Layer 2 - GND	TID #:	TIDA-00488				
PLOT NAME = Signal Layer 1	GENERATED	: 10/14/2015 10:59:12 AM			TEXAS INSTRUMENTS	



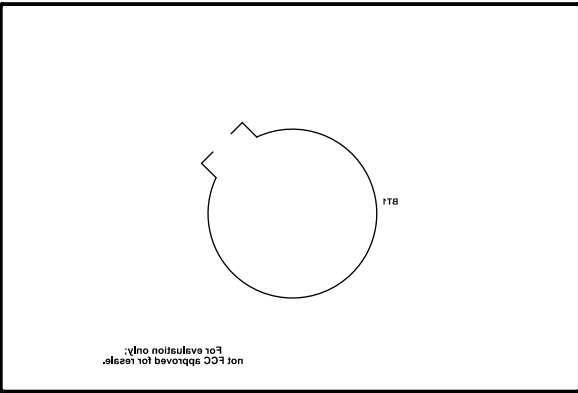
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4039	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Layer 3 - PWR	TID #: TIDA-00488		
PLOT NAME = Signal Layer 2	GENERATED : 10/14/2015 10:59:14 AM	TEXAS INSTRUMENTS	



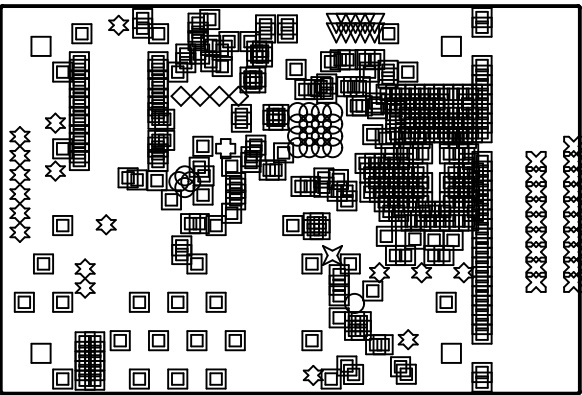
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4039	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Layer 4 - Bottom Layer	TID #: TIDA-00488		
PLOT NAME = Bottom Layer	GENERATED : 10/14/2015 10:59:15 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4039	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00488		
PLOT NAME = Bottom Solder Mask	GENERATED : 10/14/2015 10:59:17 AM	TEXAS INSTRUMENTS	

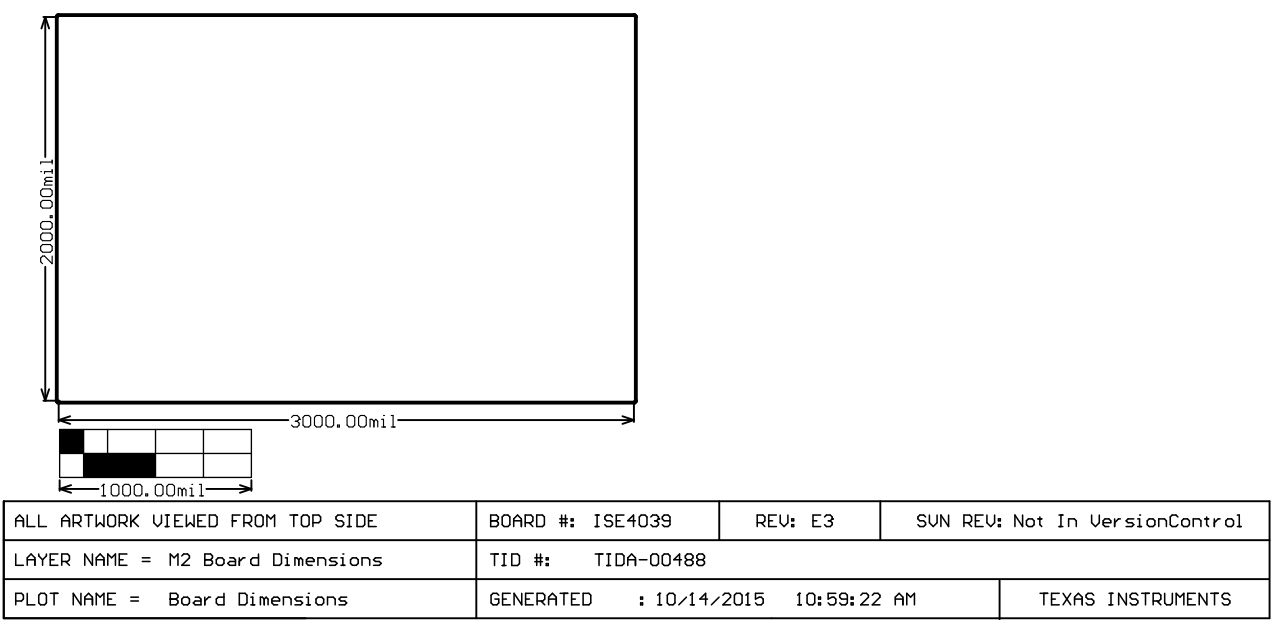


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4039	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-00488		
PLOT NAME = Bottom Overlay	GENERATED : 10/14/2015 10:59:18 AM		TEXAS INSTRUMENTS



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
○	21	7.87mil (0.200mm)	PTH	Round
■	323	10.00mil (0.254mm)	PTH	Round
⊠	19	14.96mil (0.380mm)	PTH	Round
▽	10	27.56mil (0.700mm)	PTH	Round
◇	4	39.37mil (1.000mm)	PTH	Round
☆	17	40.00mil (1.016mm)	PTH	Round
⊠	1	46.50mil (1.181mm)	PTH	Round
⊠	1	59.06mil (1.500mm)	PTH	Round
□	4	125.98mil (3.200mm)	PTH	Round
400 Total				

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: ISE4039	REV: E3	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00488		
PLOT NAME = Drill Drawing	GENERATED : 10/14/2015 10:59:20 AM		TEXAS INSTRUMENTS



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